

**PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION**

**Part Number:** [0670689001](#)  
**Status:** **Active**  
**Description:** Universal Serial Bus (USB) Shielded I/O Type B Receptacle, Right Angle, with Kinked Solder Tabs, Color White, 0.76µm (30µ") Gold(Au)Plating, Tray Pack, Lead Free

**Documents:**

[3D Model](#) [Product Specification PS-67998-0000 \(PDF\)](#)  
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

**General**

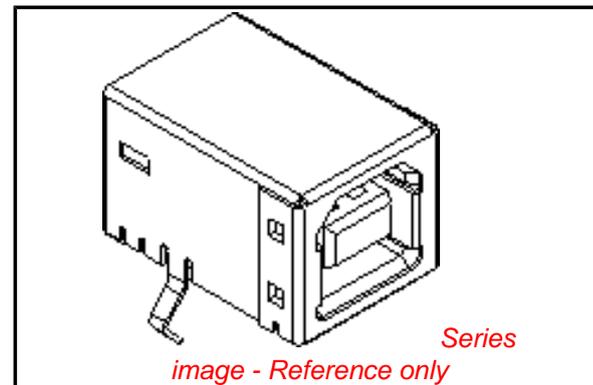
Product Family	I/O Connectors
Series	67068
Application	Wire-to-Board
Comments	Single
Component Type	Receptacle
Product Name	USB
Type	B

**Physical**

Boot Color	N/A
Circuits (Loaded)	4
Circuits (maximum)	4
Gender	Receptacle
Lock to Mating Part	Yes
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Number of Rows	2
Orientation	Right Angle
PC Tail Length (in)	0.110 In
PC Tail Length (mm)	2.80 mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness Recommended (in)	0.063 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tray
Panel Mount	No
Pitch - Mating Interface (in)	0.098 In
Pitch - Mating Interface (mm)	2.50 mm
Pitch - Term. Interface (in)	0.098 In
Pitch - Term. Interface (mm)	2.50 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.76
Plating min: Termination (µin)	75
Plating min: Termination (µm)	1.90
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	1
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	0°C to +50°C
Termination Interface: Style	Through Hole
Waterproof / Dustproof	No
Wire Size AWG	N/A

**Electrical**

Current - Maximum per Contact	1.5A
Shield Type	Full Shield



**EU RoHS**

**ELV and RoHS  
Compliant**  
**REACH SVHC  
Contains SVHC: No**  
**Halogen-Free  
Status**

**China RoHS**



**Need more information on product  
environmental compliance?**

Email [productcompliance@molex.com](mailto:productcompliance@molex.com)  
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

**Search Parts in this Series**

67068Series

**Mates With**

USB Type B Plug

Shielded  
Voltage - Maximum

Yes  
30V (RMS)

**Material Info**

Old Part Number

67068-1001

**Reference - Drawing Numbers**

Product Specification

PS-67998-0000

Sales Drawing

SD-67068-003, SD-67068-004

This document was generated on 03/31/2010

**PLEASE CHECK [WWW.MOLEX.COM](http://WWW.MOLEX.COM) FOR LATEST PART INFORMATION**

10 9 8 7 6 5 4 3 2 1

NOTES :

1. MATERIAL :  
 HOUSING : (a) HIGH TEMP. NYLON ,GLASS FIBER FILLED,UL94V-0, COLOR: BLACK,  
 (b) POLYESTER , GLASS FIBER FILLED,UL94V-0, COLOR: WHITE,  
 TERMINAL : PHOSPHOR BRONZE  
 METAL SHELL : COPPER ALLOY

2. PLATING :

TERMINAL :  
 CONTACT AREA : (a) GOLD FLASH.  
 (b) GLOD (Au), THICKNESS = 30 MICROINCH MINIMUM.  
 /0.76 MICROMETER MINIMUM.

SOLDER TAIL :  
 PURE TIN(Sn) THICKNESS= 75 MICROINCH MINIMUM .  
 /1.9 MICROMETER MINIMUM.

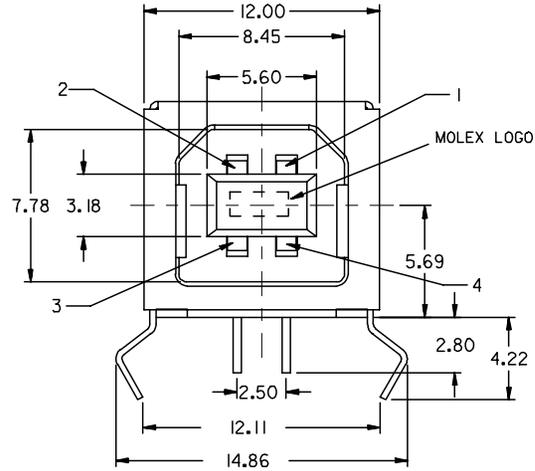
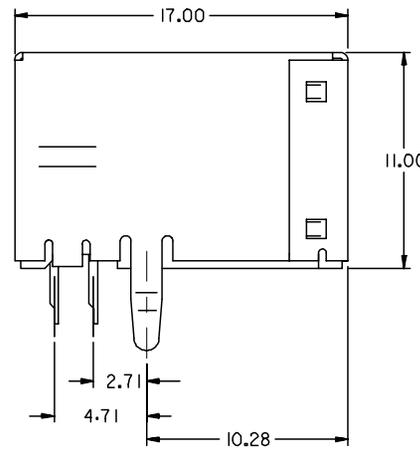
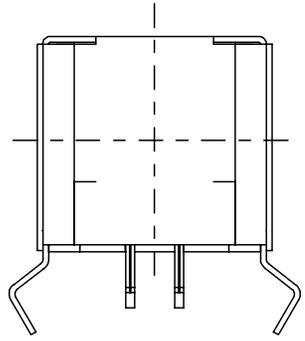
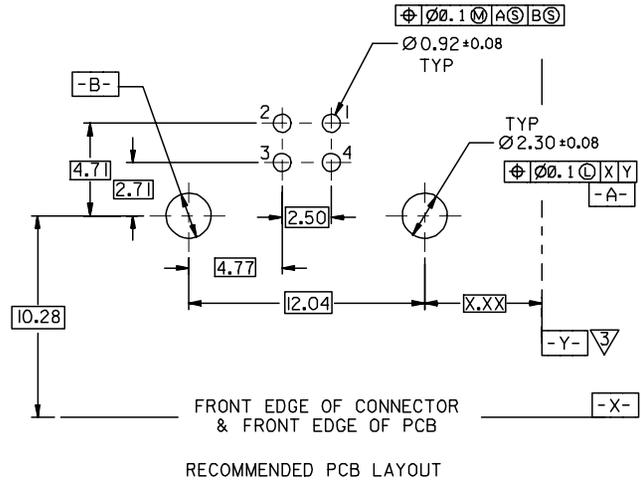
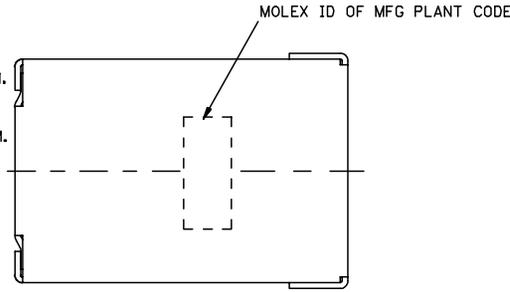
UNDER PLATE : NICKEL (Ni), THICKNESS= 50 MICROINCH MINIMUM.  
 /1.27 MICROMETER MINIMUM.

METAL SHELL :  
 PURE TIN(Sn) , THICKNESS= 50 MICROINCH MINIMUM.  
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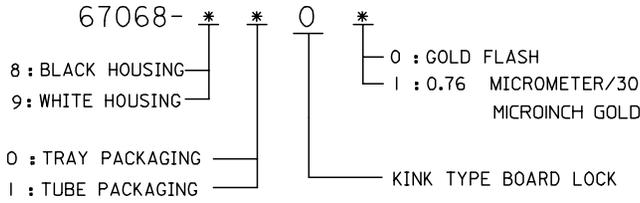
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▽ DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER  
 RECOMMENDED PCB THICKNESS : 1.60±0.05

4 PRODUCT SPECIFICATION : REFER TO PS-67998-0000



PART NUMBER LEGEND:



NEW RELEASE	DESCRIPTION
EC NO: SH2005-0142	CHIKO: HARVEY 2004/11/25
DRWN: DAVID HU 2004/11/5	APPR: TYAP 2004/11/25
A	REV

QUALITY SYMBOLS
▽=0
▽C=0

GENERAL TOLERANCES (UNLESS SPECIFIED)	
mm	INCH
4 PLACES ± ---	± ---
3 PLACES ± ---	± ---
2 PLACES ± 0.25	± ---
1 PLACE ± 0.25	± ---
ANGULAR ± 3 °	

DIMENSION STYLE		SCALE		DESIGN UNITS	
MM ONLY		4:1		METRIC	
DRAWN BY	DATE	TITLE	THIRD ANGLE PROJECTION		
DAVID HU	2004/11/05	USB B TYPE CONNECTOR	KINK TYPE BOARD LOCK		
CHECKED BY	DATE	(LEAD-FREE)			
HARVEY	2004/11/05	MOLEX INCORPORATED			
APPROVED BY	DATE	DOCUMENT NO.		SHEET NO.	
		SD-67068-003		1 OF 4	

DRAFT WHERE APPLICABLE  
 MUST REMAIN WITHIN DIMENSIONS

SEE NOTES

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

9 8 7 6 5 4 3 2 1

10 9 8 7 6 5 4 3 2 1

NOTES :

1. MATERIAL :  
 HOUSING : (a) HIGH TEMP. NYLON, GLASS FIBER FILLED, UL94V-0, COLOR: BLACK,  
 (b) POLYESTER, GLASS FIBER FILLED, UL94V-0, COLOR: WHITE,  
 TERMINAL : PHOSPHOR BRONZE  
 METAL SHELL : COPPER ALLOY

2. PLATING :  
 TERMINAL :  
 CONTACT AREA : (a) GOLD FLASH.  
 (b) GLOD (Au), THICKNESS = 30 MICROINCH MINIMUM.  
 /0.76 MICROMETER MINIMUM.

SOLDER TAIL :  
 PURE TIN(Sn) THICKNESS= 75 MICROINCH MINIMUM .  
 /1.9 MICROMETER MINIMUM.

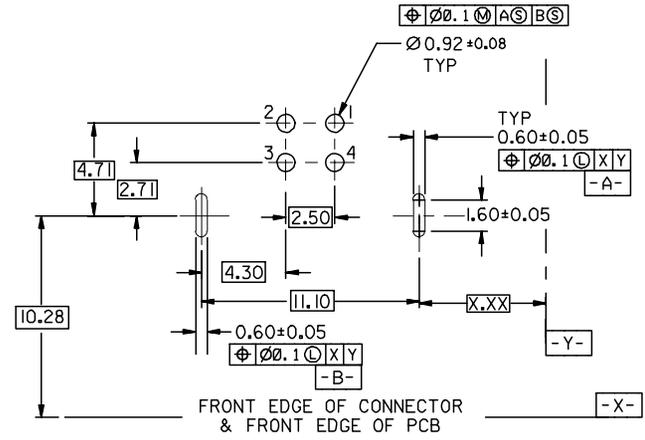
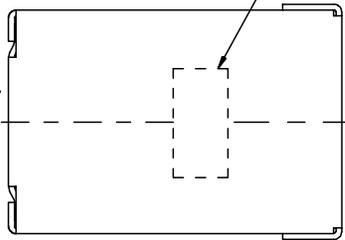
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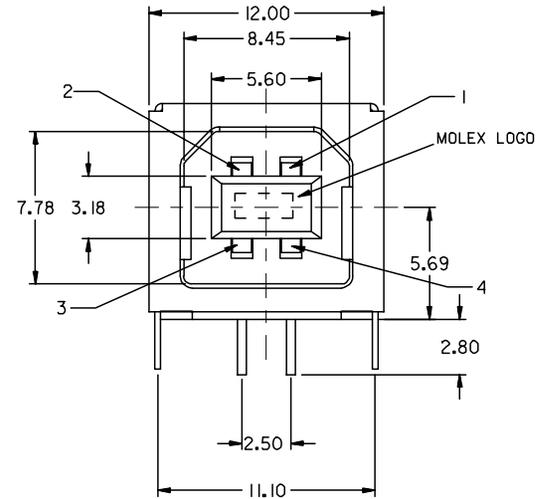
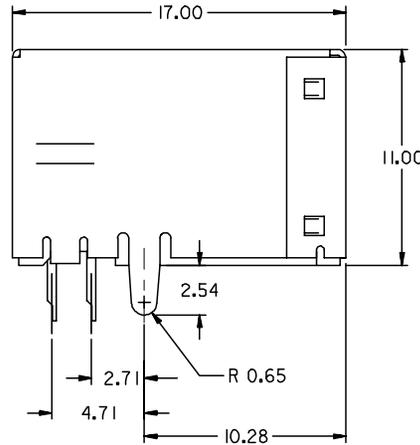
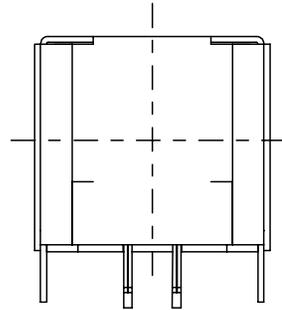
UNDER PLATE : NICKEL (Ni), THICKNESS= 50 MICROINCH MINIMUM.  
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3 DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER  
 RECOMMENDED PCB THICKNESS : 1.60±0.05  
 4 PRODUCT SPECIFICATION : REFER TO PS-67998-0000

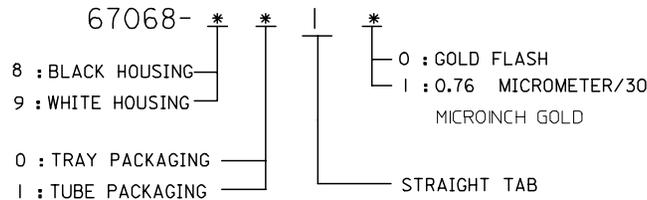
MOLEX ID OF MFG PLANT CODE



RECOMMENDED PCB LAYOUT



PART NUMBER LEGEND:



NEW RELEASE EC NO: SH2005-0142 DRWN: DAVID HU 2004/11/5 CHKD: HARVEY 2004/11/25 APPR: TYAP 2004/11/25	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	DESCRIPTION REV	▽=0	mm	INCH	DRAWN BY DAVID HU	DATE 2004/11/05	TITLE USB B TYPE CONNECTOR WITH STRAIGHT TAB (LEAD-FREE)
		▽C=0	4 PLACES ± ---	± ---	CHECKED BY 2004/11/05	DATE 2004/11/05	MOLEX INCORPORATED
			3 PLACES ± ---	± ---	APPROVED BY	DATE	
A		2 PLACES ± 0.25	± ---	MATERIAL NO.		SHEET NO. 2	
		1 PLACE ± 0.25	± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE NOTES	
		ANGULAR ± 3 °		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	

9 8 7 6 5 4 3 2 1

8 7 6 5 4 3 2 1

NOTES :  
 1. MATERIAL :  
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TERMINAL : PHOSPHOR BRONZE  
 METAL SHELL : COPPER ALLOY

2. PLATING :  
 TERMINAL :  
 CONTACT AREA : (a) GOLD FLASH.  
 (b) GL0D (Au), THICKNESS = 30 MICROINCH MINIMUM.  
 /0.76 MICROMETER MINIMUM.

SOLDER TAIL :  
 PURE TIN(Sn) THICKNESS= 75 MICROINCH MINIMUM .  
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UNDER PLATE : NICKEL (Ni), THICKNESS= 50 MICROINCH MINIMUM.  
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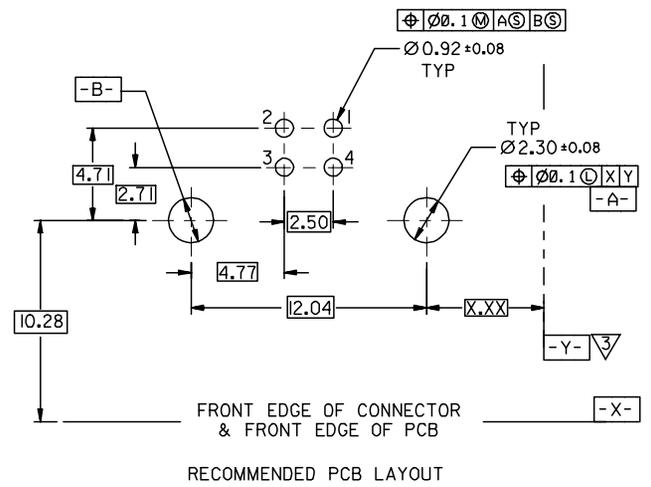
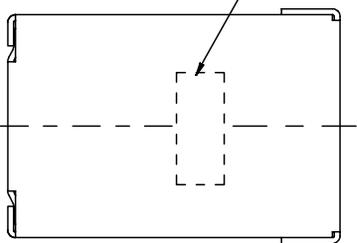
METAL SHELL :  
 PURE TIN(SN), THICKNESS= 50 MICROINCH MINIMUM.  
 /1.27 MICROMETER MINIMUM.

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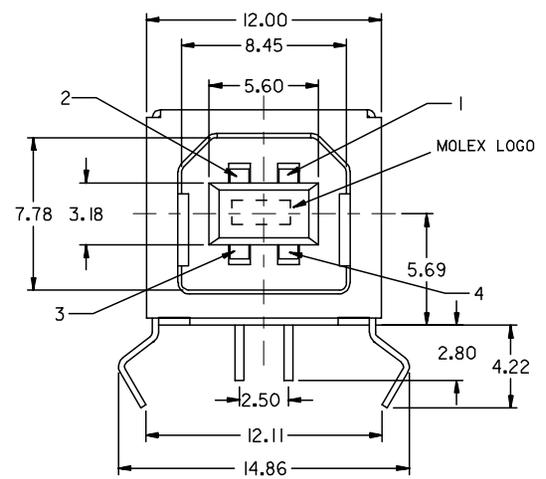
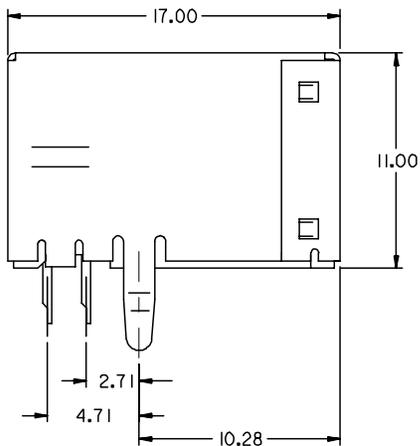
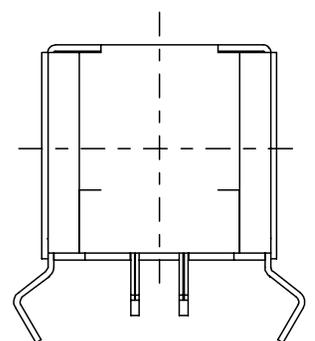
▽ DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER  
 RECOMMENDED PCB THICKNESS : 1.60±0.05

4 PRODUCT SPECIFICATION : REFER TO PS-67998-0000

MOLEX ID OF MFG PLANT CODE



FRONT EDGE OF CONNECTOR  
 & FRONT EDGE OF PCB  
 RECOMMENDED PCB LAYOUT



PART NUMBER LEGEND:  
 67068- 7041

				MATERIAL : SEE NOTES		 MOLEX TAIWAN LTD. SHEET 3 OF 4
				FINISH : SEE NOTES		
				WIRE RANGE :		GENERAL TOLERANCES ANGLE : ± 3° DIM : ± .25/.010
				INS. RANGE :		ENG. NO.: SD-67068-003
A	NEW RELEASE FOR LEAD-FREE		DAVID HU	2004/11/5		REV A
LTR	REVISION RECORD	ECN	DR	DATE	DRAWN BY 2004/11/5 DAVID HU	CHK'D BY
REVISE ONLY ON CAD SYSTEM					APPR'D BY	SCALE 4 : 1
TITLE : HIGH TEMP.USB B TYPE CONNECTOR KINK TYPE BOARD LOCK (LEAD-FREE)						

DO NOT SCALE DRAWING

ENG. NO SDA-67068-\*\*\*\*

EDP NO.

SIMILAR ITEM

CAD FILE : S6706802

DO NOT SCALE DRAWING

NOTES :

1. MATERIAL :

HOUSING : (a) HIGH TEMP. NYLON, GLASS FIBER FILLED, UL94V-0, COLOR: BLACK,

TERMINAL : PHOSPHOR BRONZE  
METAL SHELL : COPPER ALLOY

2. PLATING :

TERMINAL :

CONTACT AREA : (a) GOLD FLASH.  
(b) GL0D (Au), THICKNESS = 30 MICROINCH MINIMUM.  
/0.76 MICROMETER MINIMUM.

SOLDER TAIL :

PURE TIN(Sn) THICKNESS= 75 MICROINCH MINIMUM .  
/1.9 MICROMETER MINIMUM.

UNDER PLATE : NICKEL (Ni), THICKNESS= 50 MICROINCH MINIMUM.

/1.27 MICROMETER MINIMUM.

METAL SHELL :

PURE TIN(Sn) THICKNESS= 50 MICROINCH MINIMUM.  
/1.27 MICROMETER MINIMUM.

UNDER PLATE : NICKEL (Ni), THICKNESS= 50 MICROINCH MINIMUM.

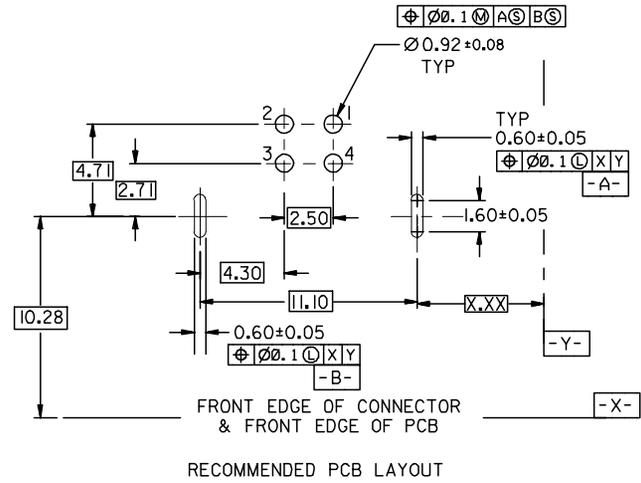
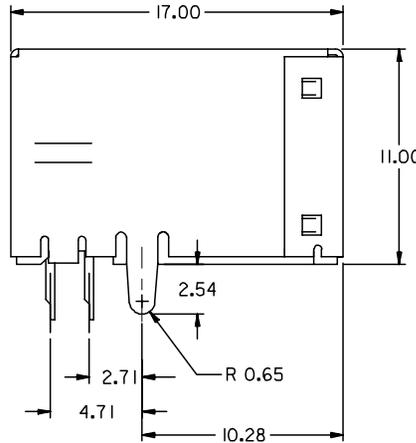
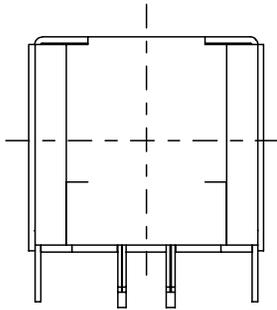
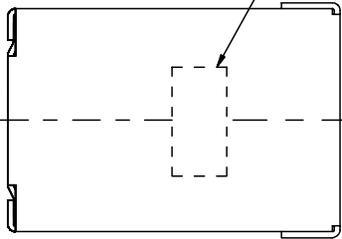
/1.27 MICROMETER MINIMUM.

3 DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER

RECOMMENDED PCB THICKNESS : 1.60±0.05

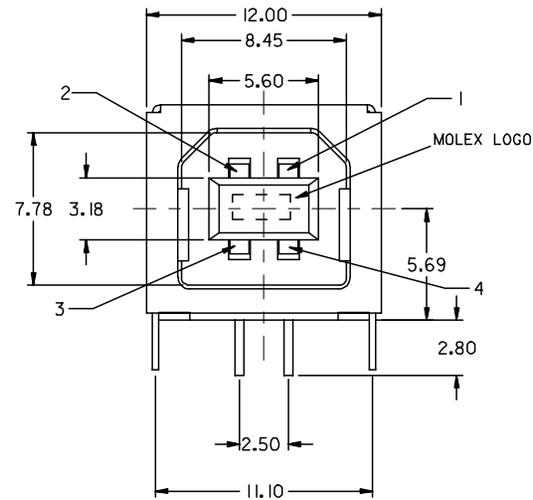
4 PRODUCT SPECIFICATION : REFER TO PS-67998-0000

MOLEX ID OF MFG PLANT CODE



FRONT EDGE OF CONNECTOR & FRONT EDGE OF PCB

RECOMMENDED PCB LAYOUT



PART NUMBER LEGEND:

67068- 7051

				MATERIAL : SEE NOTES		 MOLEX TAIWAN LTD. SHEET 4 OF 4
				FINISH : SEE NOTES		
				WIRE RANGE :		GENERAL TOLERANCES ANGLE : ± 3° DIM : ± .25/0.10
				INS. RANGE :		ENG. NO.: SD-67068-003
A	NEW RELEASE FOR LEAD-FREE	DAVID HU	2004/11/5	DRAWN BY 2004/11/5 DAVID HU		REV A
LTR	REVISION RECORD	ECN	DR	DATE	CHK'D BY	TITLE : HIGH TEMP USB B TYPE CONNECTOR WITH STRAIGHT TAB (LEAD-FREE)
				APPR'D BY		SCALE 4 : 1

NOTES:

1.MATERIAL:

HOUSING:

- (a)HIGH TEMP,NYLON,GLASS FIBRE FILLED,UL94V-0,COLOR: 8BALCK
- (b)POLYESTER(PBT),30% GLASS FIBER FILLED,UL94V-0,COLOR: 9WHITE
- TERMINAL: PHOSPHOR BRONZE
- METAL SHELL: COPPER ALLOY

2.PLATING:

TERMINAL:

- (c)GOLD FLASH ON CONTACT AREA,75 MICROINCH MINIMUM PURE TIN(Sn) ON SOLDER TAIL,UNDER 50 MICROINCH MINIMUM NICKEL(Ni) PLATE.
- (d)30 MICROINCH MINIMUM GOLD(Au) ON CONTACT AREA,75 MICROINCH MINIMUM PURE TIN(Sn) ON SOLDER TAIL,UNDER 50 MICROINCH MINIMUM NICKEL(Ni) PLATE.
- (e)GOLD FLASH ON CONTACT AREA,75 MICROINCH MINIMUM MATTE TIN(Sn) ON SOLDER TAIL,UNDER 50 MICROINCH MINIMUM NICKEL(Ni) PLATE.
- (f)30 MICROINCH MINIMUM GOLD(Au) ON CONTACT AREA,75 MICROINCH MINIMUM MATTE TIN(Sn) ON SOLDER TAIL,UNDER 50 MICROINCH MINIMUM NICKEL(Ni) PLATE.

METAL SHELL:

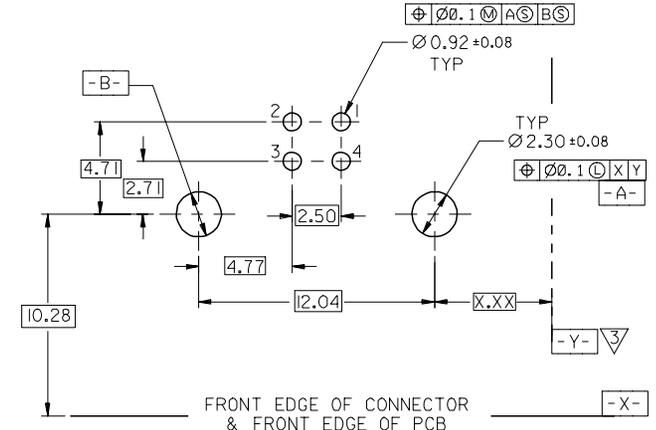
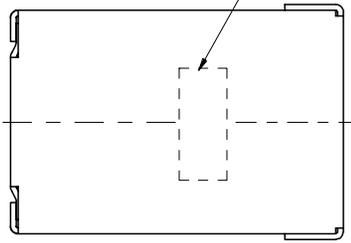
- (g)50 MICROINCH MINIMUM PURE TIN(Sn),UNDER 50 MICROINCH MINIMUM NICKEL(Ni) PLATE.
- (h)50 MICROINCH MINIMUM MATTE TIN(Sn),UNDER 50 MICROINCH MINIMUM NICKEL(Ni) PLATE.

3.DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.

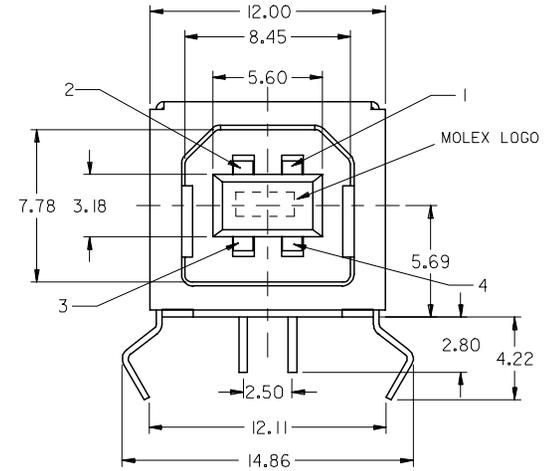
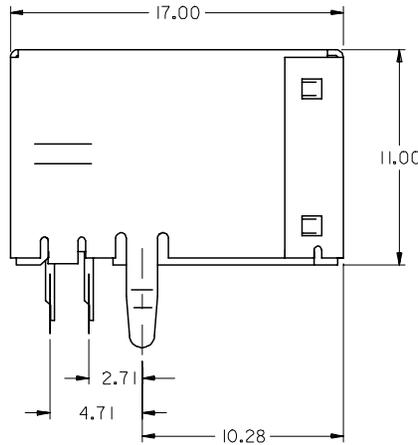
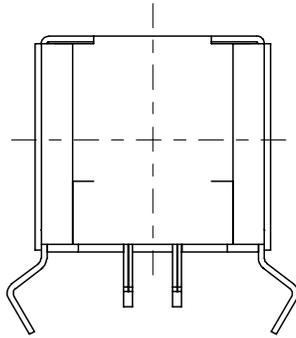
RECOMMENDED PCB THICKNESS : 1.60±0.05

4.PRODUCT SPECIFICATION : REFER TO PS-67998-0000

MOLEX ID OF MFG PLANT CODE



FRONT EDGE OF CONNECTOR & FRONT EDGE OF PCB  
RECOMMENDED PCB LAYOUT



P/N	HOUSING COLOR	PLATING
67068-8000	BLACK	GOLD FLASH SEE NOTES(2-(c),2-(g))
67068-8001	BLACK	30MICROINCH Au SEE NOTES(2-(d),2-(g))
67068-9000	WHITE	GOLD FLASH SEE NOTES(2-(c),2-(g))
67068-9001	WHITE	30MICROINCH Au SEE NOTES(2-(d),2-(g))
67068-8012	BLACK	30MICROINCH Au SEE NOTES(2-(f),2-(h))
67068-8013	BLACK	GOLD FLASH SEE NOTES(2-(e),2-(h))

REVISED	EC NO: SH2007-0468	2007/01/19
	DRWN:HYE01	2007/01/19
	CHKD:WANG	2007/01/19
	APPR: JNCHEN	2007/01/26
REV	DESCRIPTION	

QUALITY SYMBOLS	▽=0
	∇=0

GENERAL TOLERANCES (UNLESS SPECIFIED)	
	mm
	INCH
4 PLACES	± --- ± ---
3 PLACES	± --- ± ---
2 PLACES	± 0.25 ± .010
1 PLACE	± 0.25 ± .010
ANGULAR ± 3 °	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
MM ONLY		4:1	METRIC	
DRAWN BY	DATE	TITLE		
DAVID HU	2004/11/05	USB B TYPE CONNECTOR LEAD-FREE		
CHECKED BY	DATE			
HARVEY	2004/11/05			
APPROVED BY	DATE			
MATERIAL NO.		DOCUMENT NO.	SHEET NO.	
		SD-67068-004	1 OF 1	
SIZE	SEE NOTES			
A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

MOLEX INCORPORATED	
SD-67068-004	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

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